

# R2A20112SP/DD

R19DS0079EJ0400 Rev.4.00

## Critical Conduction Mode Interleaved PFC Control IC

Dec 13, 2014

### **Description**

The R2A20112 controls a boost converter to provide an active power factor correction.

The R2A20112 adopts critical conduction mode for power factor correction and realizes high efficiency and a low switching noise by zero current switching.

Interleaving function improve ripple current on input or output capacitor by 180 degrees phase shift.

The feedback loop open detection, two mode overvoltage protection, overcurrent protection are built in the R2A20112, and can constitute a power supply system of high reliability with few external parts.

#### **Features**

- Maximum Ratings
  - Supply voltage Vcc: 24 V
  - Operating junction temperature Tjopr: –40 to +150°C
- Electrical characteristics
  - VREF output voltage VREF:  $5.0 \text{ V} \pm 3\%$
  - UVLO operation start voltage VH:  $10.5 \text{ V} \pm 0.7 \text{ V}$
  - UVLO operation shutdown voltage VL:  $9.3 \text{ V} \pm 0.5 \text{ V}$
  - UVLO hysteresis voltage Hysuvl:  $1.2 \text{ V} \pm 0.5 \text{ V}$
- Functions
  - Boost converter control with critical conduction mode
  - Interleaving control
  - Two mode overvoltage protection

Model: Dynamic OVP corresponding to a voltage rise by load change

Mode2: Static OVP corresponding to overvoltage in stable

- Feedback loop open detection
- Master and Slave independence overcurrent protection
- 280 μs restart timer
- Package lineup: Pb-free SOP-16/DILP-16\*

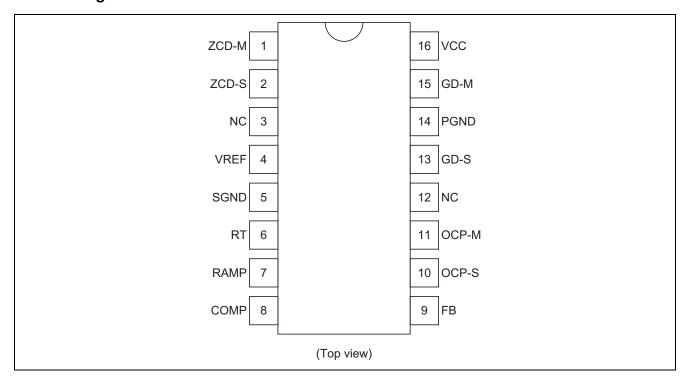
Note: \* Not recommend for new design.

### **Ordering Information**

Part No.	Package Name	Package Code	Taping Spec.	
R2A20112SPW0	FP-16DAV	PRSP0016DH-B	2000 pcs./one taping product	
R2A20112DDU0 *	DP-16FV	PRDP0016AE-B	_	

Note: \* Not recommend for new design.

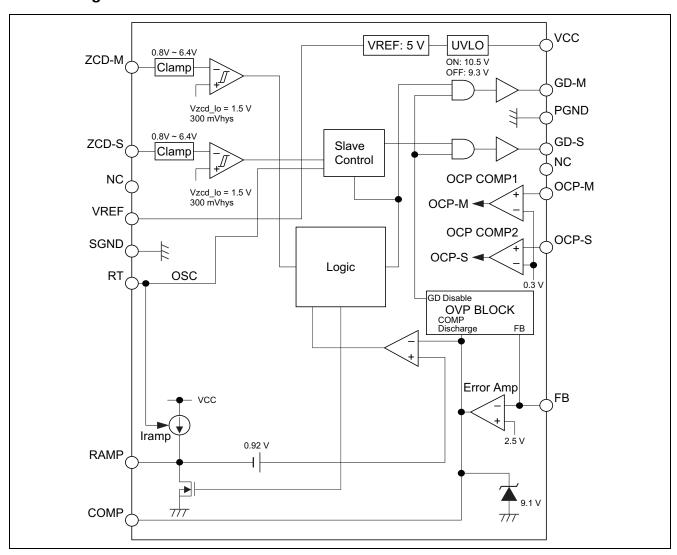
### **Pin Arrangement**



#### **Pin Functions**

Pin No.	Pin Name	Input/Output	Function		
1	ZCD-M	Input	Master converter zero current detection input terminal		
2	ZCD-S	Input	Slave converter zero current detection input terminal		
3	N.C.	_	Open		
4	VREF	Output	Reference voltage output terminal		
5	SGND	_	Ground for small signal circuit		
6	RT	Input/Output	Oscillator frequency setting terminal		
7	RAMP	Input/Output	Ramp waveform setting terminal		
8	COMP	Output	Error amplifier output terminal		
9	FB	Input	Error amplifier input terminal		
10	OCP-S	Input	Slave converter overcurrent detection terminal		
11	OCP-M	Input	Master converter overcurrent detection terminal		
12	N.C.	_	Open		
13	GD-S	Output	Slave converter Power MOSFET drive terminal		
14	PGND		Ground for power stage		
15	GD-M	Output	Master converter Power MOSFET drive terminal		
16	VCC	Input	Supply voltage terminal		

#### **Block Diagram**



#### **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Ratings	Unit	Note	
Supply voltage	Vcc	-0.3 to 24	V		
GD-M Peak current	lpk-gdm	±200	mA	3	
GD-M DC current	ldc-gdm	±10	mA		
GD-S Peak current	lpk-gds	±200	mA	3	
GD-S DC current	ldc-gds	±10	mA		
ZCD terminal current	Izcd	±10	mA		
RT terminal current	Irt	-200	μΑ		
Vref terminal current	Iref	<b>-</b> 5	mA		
COMP terminal current	Icomp	±1	mA		
Terminal voltage	Vt-group1	-0.3 to Vcc	V	4	
	Vt-group2	-0.3 to Vref	V	5	
Vref terminal voltage	Vt-ref	-0.3 to Vref+0.3	V		
Power dissipation	Pt	1	W	6	
Operating junction temperature	Tj-opr	-40 to +150	°C		
Storage temperature	Tstg	-55 to +150	°C		

Notes: 1. Rated voltages are with reference to the SGND terminal.

- 2. For rated currents, inflow to the IC is indicated by (+), and outflow by (-).
- 3. Shows the transient current when driving a capacitive load.
- 4. This is the rated voltage for the following pins: RAMP, FB
- 5. This is the rated voltage for the following pins: RT, OCP-M , OCP-S
- 6. In case of R2A20112DD (DILP):  $\theta ja = 120^{\circ}C/W$  (Not recommend for new design) In case of R2A20112SP (SOP):  $\theta ja = 120^{\circ}C/W$  This value is a thing mounting on  $40 \times 40 \times 1.6$  [mm], a glass epoxy board of wiring density 10%.

#### **Electrical Characteristics**

 $(Ta = 25^{\circ}C, Vcc = 12 \text{ V}, RT = 22 \text{ k}\Omega, OCP = GND, CRAMP = 680 \text{ pF}, RZCD-GND = 51 \text{ k}\Omega, FB = COMP)$ 

	Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Supply	UVLO Turn-on threshold	Vuvlh	9.8	10.5	11.2	V	
	UVLO Turn-off threshold	VuvII	8.8	9.3	9.8	V	
	UVLO hysteresis	Hysuvl	0.7	1.2	1.7	V	
	Standby current	Istby	_	120	200	μΑ	Vcc = 8.9 V, ZCD = Open
	Operating current	Icc	_	4.9	7.0	mA	
VREF	Output voltage	Vref	4.85	5.00	5.15	V	Isource = -1 mA
	Line regulation	Vref-line	_	5	20	mV	Isource = −1 mA,
							Vcc = 10 V to 24 V
	Load regulation	Vref-load	_	5	20	mV	Isource = -1 mA to -5 mA
	Temperature stability	dVref	_	±80	_	ppm/°C	Ta = $-40$ to 125°C * <sup>1</sup>

Note: 1. Design spec.

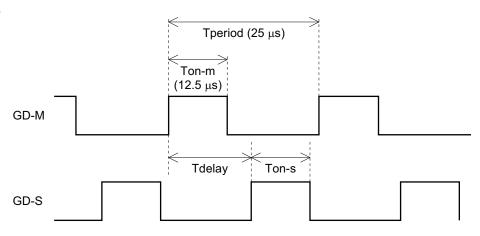
### **Electrical Characteristics** (cont.)

 $(Ta = 25^{\circ}C, Vcc = 12 \text{ V}, RT = 22 \text{ k}\Omega, OCP = GND, CRAMP = 680 \text{ pF}, RZCD-GND = 51 \text{ k}\Omega, FB = COMP)$ 

ltem		Symbol	Min	Тур	Max	Unit	Test Conditions
Error	Feedback voltage	Vfb	2.40	2.50	2.60	V	FB-COMP short, RAMP = 0 V
amplifier	Input bias current	Ifb	-0.5	0	0.5	μΑ	Measured pin: FB
	Open loop gain	Av	_	60	_	dB	*1
	Upper clamp voltage	Vclamp-comp	8.0	9.1	10.6	V	FB = 2.0 V, COMP: Open
	Low voltage	VI-comp	_	0.1	0.3	V	FB = 3.0 V, COMP: Open
	Source current	Isrc-comp	_	-120	_	μΑ	FB = 1.5 V, COMP = 2.5 V
	Sink current 1	Isnkcomp1	_	120	_	μΑ	*1
	Sink current 2	Isnkcomp2	_	300	_	μΑ	FB = 3.5 V, COMP = 2.5 V
	Transconductance	gm	150	200	290	μs	$FB = 2.45 \text{ V} \leftrightarrow 2.55 \text{ V},$ $COMP = 2.5 \text{ V}$
RAMP	RAMP charge current	lc-ramp	130	150	170	μΑ	RAMP = 0 V to 7 V
	RAMP discharge current	ld-ramp	7	16	29	mA	FB = 1 V, COMP = 2 V, RAMP = 0 V to 1.5 V to 1 V
	Low voltage	VI-ramp	_	17	200	mV	$FB = 1 \text{ V, COMP} = 3 \text{ V,}$ $RAMP = 0 \text{ V to } 2.5 \text{ V to open}$ $Isink = 100 \ \mu\text{A}$
Zero	Upper clamp voltage	Vzcdh	5.8	6.4	7.0	V	Isource = -3 mA
current	Lower clamp voltage	Vzcdl	0.3	0.8	1.3	V	Isink = 3 mA
detector	ZCD low threshold voltage	Vzcd_lo	1.05	1.50	1.75	V	*1
	ZCD hysteresis	Hyszcd	180	300	390	mV	*1
	Input bias current	Izcd	-1	_	1	μΑ	1.2 V < Vzcd < 5 V
Slave	Phase delay	Phase	160	180	200	deg.	*1, *2
control	On time ratio	Ton-ratio	<b>-</b> 5	_	5	%	*1, *2
Restart	Restart time delay	Tstart	210	280	350	μs	Cramp = 3300 pF FB = 2.0 V, COMP = 5 V

Notes: 1. Design spec.

2.



Phase = 
$$\frac{\text{Tdelay}}{\text{Tperiod}} \times 360 \text{ [deg.]}$$

Ton-ratio = 
$$\left(1 - \frac{\text{Ton-s}}{\text{Ton-m}}\right) \times 100 \, [\%]$$

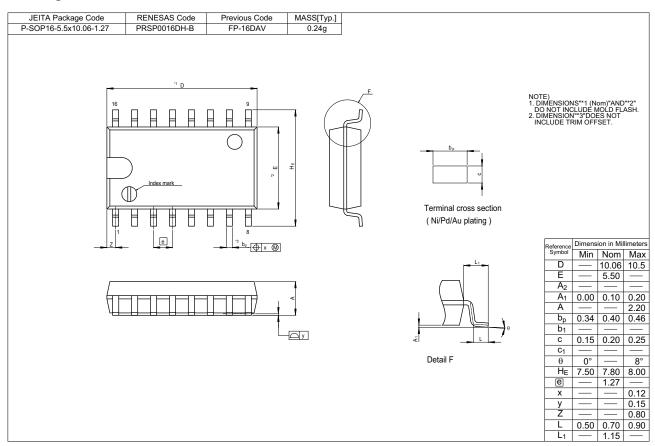
## **Electrical Characteristics** (cont.)

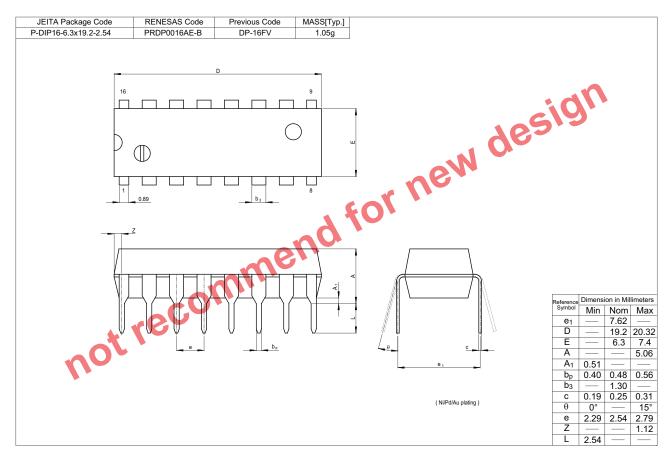
 $(Ta = 25^{\circ}C, Vcc = 12 \text{ V}, RT = 22 \text{ k}\Omega, OCP = GND, CRAMP = 680 \text{ pF}, RZCD-GND = 51 \text{ k}\Omega, FB = COMP)$ 

Item		Symbol	Min	Тур	Max	Unit	Test Conditions
Gate	Master gate drive rise time	tr-gdm	_	30	100	ns	CL = 100 pF, Cramp = 3300 pF
drive							FB = 2.0 V, COMP = 5 V
	Slave gate drive rise time	tr-gds	_	30	100	ns	CL = 100 pF, Cramp = 3300 pF
							FB = 2.0 V, COMP = 5 V
	Master gate drive fall time	tf-gdm	_	30	100	ns	CL = 100 pF, Cramp = 3300 pF
							FB = 2.0 V, COMP = 5 V
	Slave gate drive fall time	tf-gds	_	30	100	ns	CL = 100 pF, Cramp = 3300 pF
							FB = 2.0 V, COMP = 5 V
	Master gate drive low	Vol1-gdm	_	0.05	0.2	V	Isink = 2 mA
	voltage	Vol2-gdm	_	0.03	0.7		Isink = 1 mA, VCC = 5 V
	Master gate drive high voltage	Voh-gdm	11.5	11.9	_	V	Isource = -2 mA
	Slave gate drive low voltage	Vol1-gds	_	0.05	0.2	V	Isink = 2 mA
		Vol2-gds	_	0.03	0.7		Isink = 1 mA, VCC = 5 V
	Slave gate drive high voltage	Voh-gds	11.5	11.9	_	V	Isource = -2 mA *1
Over current protection	OCP threshold voltage	Vocp	0.27	0.3	0.33	V	
Over	Dynamic OVP threshold	Vdovp	VFB×	VFB×	VFB×	V	
voltage	voltage		1.035	1.050	1.065		
protection	Static OVP threshold	Vsovp	VFB×	VFB×	VFB×	V	COMP = Open
	voltage		1.075	1.090	1.105		
	Static OVP hysteresis	Hys-sovp	50	100	150	mV	COMP = Open
	FB open detect threshold voltage	Vfbopen	0.45	0.50	0.55	V	COMP = Open
	FB open detect hysteresis	Hysfbopen	0.16	0.20	0.24	V	COMP = Open

Note: 1. Design spec.

#### **Package Dimensions**





#### **Notice**

- 1. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
- 2. Renesas Electronics has used reasonable care in preparing the information included in this document, but Renesas Electronics does not warrant that such information is error free. Renesas Electronics assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein
- 3. Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or
- 4. You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from such alteration, modification, copy or otherwise misappropriation of Renesas Electronics product
- 5. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The recommended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below

"Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots etc.

"High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anti-crime systems; and safety equipment etc.

Renesas Electronics products are neither intended nor authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems, surgical implantations etc.), or may cause serious property damages (nuclear reactor control systems, military equipment etc.). You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application for which it is not intended. Renesas Electronics shall not be in any way liable for any damages or loss incurred by you or third parties arising from the use of any Renesas Electronics product for which the product is not intended by Renesas Electronics

- 6. You should use the Renesas Electronics products described in this document within the range specified by Renesas Electronics, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas Electronics shall have no liability for malfunctions or damages arising out of the ise of Renesas Electronics products beyond such specified ranges.
- 7. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or systems manufactured by you.
- 8. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Renesas Electronics assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
- 9. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You should not use Renesas Electronics products or technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. When exporting the Renesas Electronics products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations
- 10. It is the responsibility of the buyer or distributor of Renesas Electronics products, who distributes, disposes of, or otherwise places the product with a third party, to notify such third party in advance of the contents and conditions set forth in this document, Renesas Electronics assumes no responsibility for any losses incurred by you or third parties as a result of unauthorized use of Renesas Electronics products.
- 11. This document may not be reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics
- 12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products, or if you have any other inquiries. (Note 1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its majority-owned subsidiaries
- (Note 2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics



#### SALES OFFICES

#### Renesas Electronics Corporation

http://www.renesas.com

Refer to "http://www.renesas.com/" for the latest and detailed information

Renesas Electronics America Inc. 2880 Scott Boulevard Santa Clara, CA 95050-2554, U.S.A. Tel: +1-408-588-6000, Fax: +1-408-588-6130

Renesas Electronics Canada Limited 1101 Nicholson Road, Newmarket, Ontario L3Y 9C3, Canada Tel: +1-905-898-5441, Fax: +1-905-898-3220

Renesas Electronics Europe Limited Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K Tel: +44-1628-651-709, Fax: +44-1628-651-804

Renesas Electronics Europe GmbH

Arcadiastrasse 10, 40472 Düsseldorf, Germany Tel: +49-211-65030, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd. 7th Floor, Quantum Plaza, No.27 ZhiChunLu Haidian District, Beijing 100083, P.R.China Tel: +86-10-2035-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.
Unit 301, Tower A, Central Towers, 555 LanGao Rd., Putuo District, Shanghai, China
Tel: +86-21-2226-088, Fax: +86-21-2226-0999

Renesas Electronics Hong Kong Limited
Unit 1601-1613, 161F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong
Tel: +852-2886-9318, Fax: +852 2886-9022/9044

Renesas Electronics Taiwan Co., Ltd. 13F, No. 363, Fu Shing North Road, Taipei, Taiv Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd. 80 Bendemeer Road, Unit #06-02 Hyflux Innovation Centre Singapore 339949 Tel: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn.Bhd.
Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia
Tel: +60-3-7955-9390, Fax: +60-3-7955-9510

Renesas Electronics Korea Co., Ltd. 12F., 234 Teheran-ro, Gangnam-Gu, Seoul, 135-080, Korea Tel: +82-2-558-3737, Fax: +82-2-558-5141

© 2013 Renesas Electronics Corporation. All rights reserved.